

## **RQJ0603LGDQA**

# Silicon P Channel MOS FET Power Switching

REJ03G1274-0400 Rev.4.00 May 26, 2006

#### **Features**

- Low on-resistance  $R_{DS(on)} = 158 \text{ m}\Omega \text{ typ } (V_{GS} = -10 \text{ V}, I_D = -0.9 \text{ A})$
- Low drive current
- High speed switching
- 4.5 V gate drive

#### **Outline**

RENESAS Package code: PLSP0003ZB-A (Package name: MPAK)

3
0
1. Source 2. Gate 3. Drain

Note: Marking is "LG".

#### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

			(14 =0 ,
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	-60	V
Gate to source voltage	V <sub>GSS</sub>	+10 / -20	V
Drain current	I <sub>D</sub>	-1.8	Α
Drain peak current	I <sub>D(Pulse)</sub> Note1	-4.5	А
Body - drain diode reverse drain current	I <sub>DR</sub>	-1.8	А
Channel dissipation	Pch Note2	0.8	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. When using the glass epoxy board (FR-4:  $40\times40\times1$  mm)

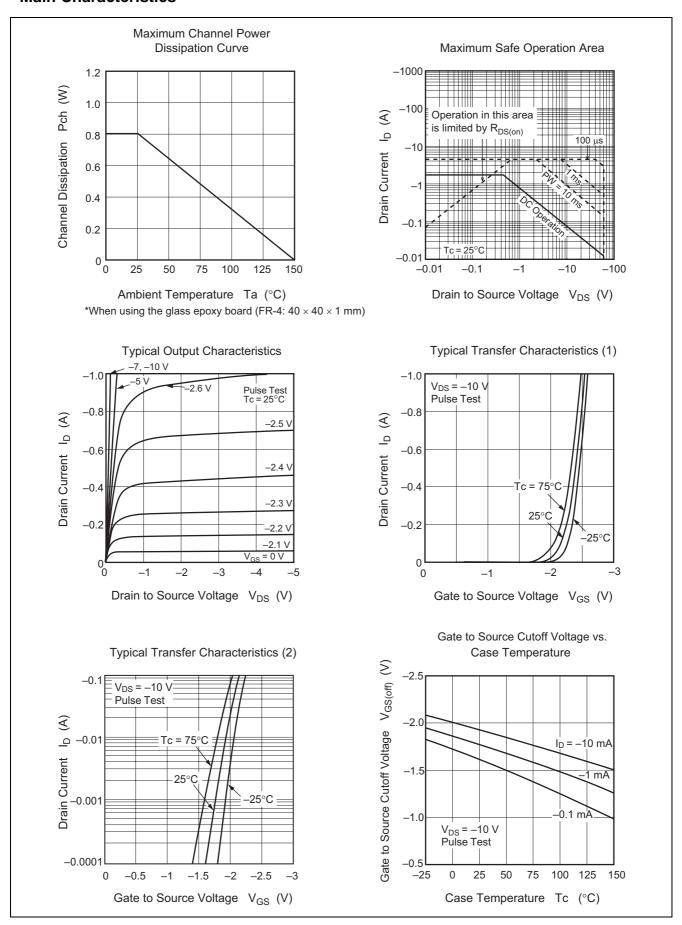
### **Electrical Characteristics**

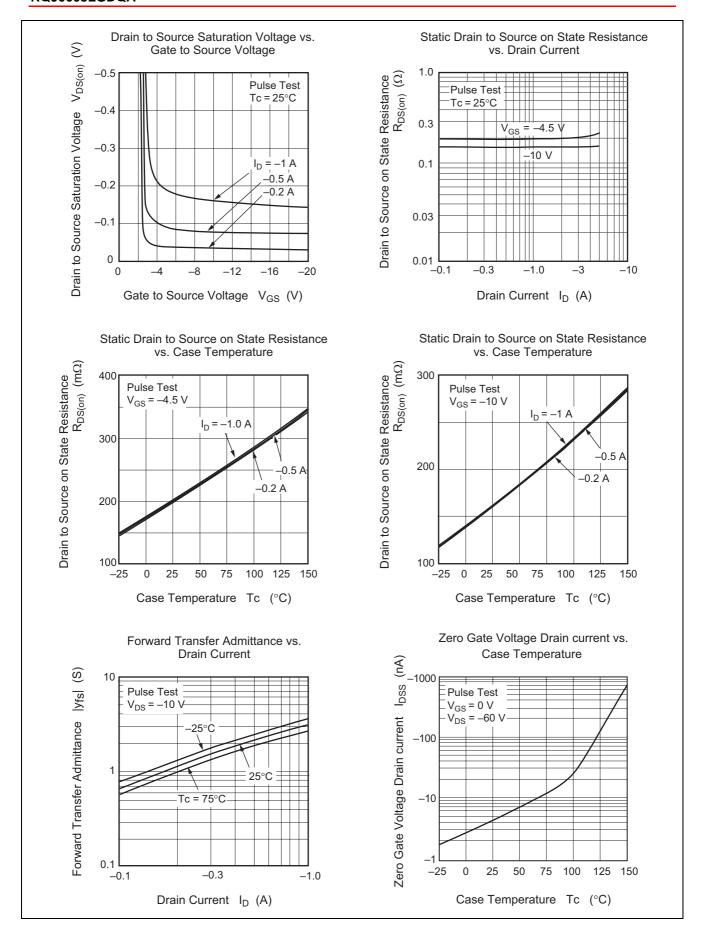
 $(Ta = 25^{\circ}C)$ 

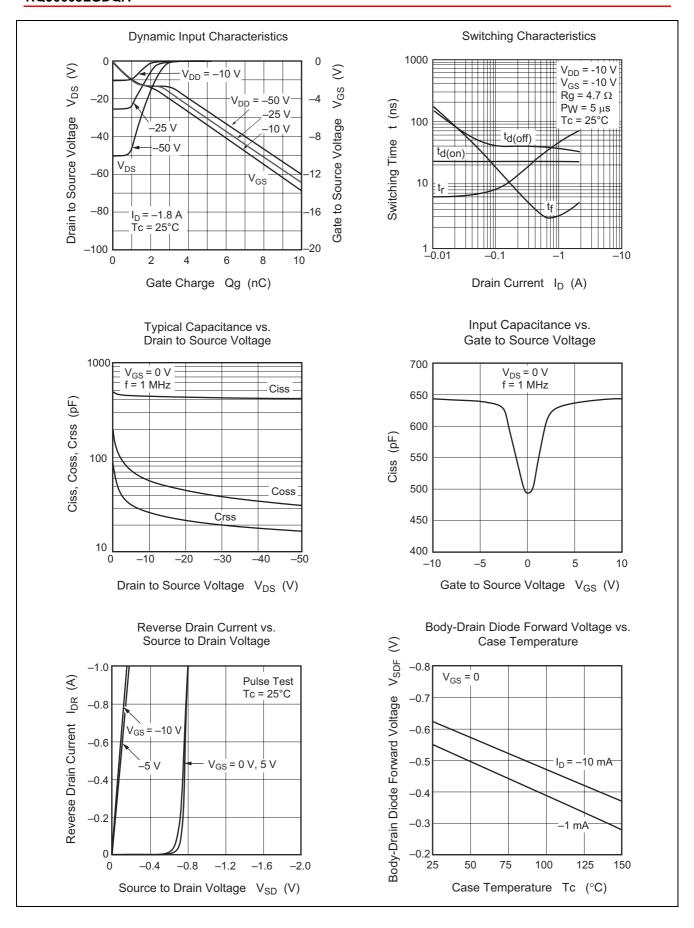
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-60	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	+10	_	_	V	$I_G = +100  \mu A,  V_{DS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	-20	_		V	$I_G = -100 \mu\text{A},  V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>		_	+10	μΑ	$V_{GS} = +8 \text{ V}, V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>		_	-10	μΑ	$V_{GS} = -16 \text{ V}, V_{DS} = 0$
Drain to source leak current	I <sub>DSS</sub>	_	_	-1	μΑ	$V_{DS} = -60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	_	-2.0	V	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$
Drain to source on state resistance	R <sub>DS(on)</sub>	_	158	198	mΩ	$I_D = -0.9 \text{ A}, V_{GS} = -10 \text{ V}^{\text{Note3}}$
	R <sub>DS(on)</sub>	_	196	275	mΩ	$I_D = -0.9 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note3}}$
Forward transfer admittance	y <sub>fs</sub>	1.6	2.7	_	S	$I_D = -0.9 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	440	_	pF	$V_{DS} = -10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	59	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	28	_	pF	
Turn - on delay time	t <sub>d(on)</sub>	_	22	_	ns	$I_D = -0.5 \text{ A}, V_{GS} = -10 \text{ V},$
Rise time	t <sub>r</sub>	_	26	_	ns	$R_L = 20 \Omega$ , $Rg = 4.7 \Omega$
Turn - off delay time	$t_{d(off)}$	_	38	_	ns	
Fall time	t <sub>f</sub>	_	3.2	_	ns	
Total gate charge	Qg		7.4		nC	$V_{DD} = -10 \text{ V}, V_{GS} = -10 \text{ V},$
Gate to source charge	Qgs	_	1.0	_	nC	$I_D = -1.8A$
Gate to drain charge	Qgd	_	1.1	_	nC	
Body - drain diode forward voltage	$V_{DF}$	_	-0.8	_	V	$I_F = -1.5 \text{ A}, V_{GS} = 0^{\text{Note3}}$

Notes: 3. Pulse test

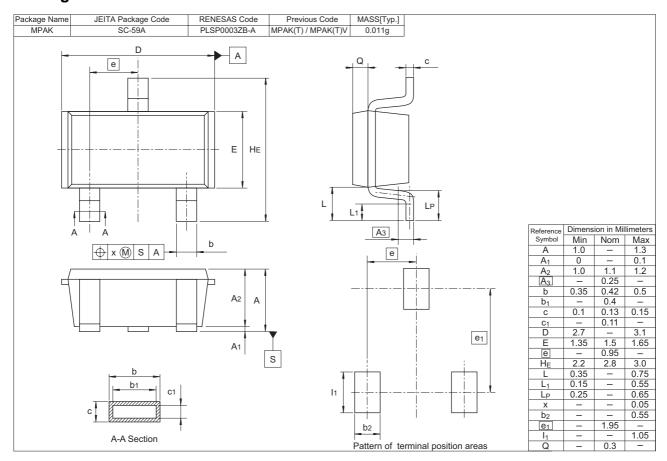
#### **Main Characteristics**







#### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
RQJ0603LGDQATL-E	3000 pcs.	φ178 mm reel, 8 mm Emboss taping

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